

Vishay Siliconix

N-Channel 40-V (D-S) 175 °C MOSFET

| PRODUCT SUMMARY | | | | | |
|--------------------------|--|-----------------|--|--|--|
| V _{(BR)DSS} (V) | V _{(BR)DSS} (V) r _{DS(on)} (Ω) | | | | |
| 40 | 0.0074 at V _{GS} = 10 V | 70 ^a | | | |
| | 0.011 at V _{GS} = 4.5 V | 67 | | | |

FEATURES

- TrenchFET[®] Power MOSFET
- 175 °C Junction Temperature
- Low Threshold



APPLICATIONS

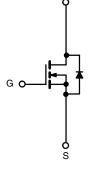
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Motor Control



TO-263

G D S Top View



Ordering Information: SUM70N04-07L-E3 (Lead (Pb)-free)

N-Channel MOSFET

| ABSOLUTE MAXIMUM RATING | S T _C = 25 °C, unless oth | erwise noted | | |
|---|---|--------------------|------------------|-----|
| Parameter | Symbol | Limit | Unit | |
| Drain-Source Voltage | V _{DS} | 40 | v | |
| Gate-Source Voltage | V _{GS} | ± 20 | v | |
| Continuous Drain Current (T _{.I} = 175 °C) | T _C = 25 °C | 1 | 70 ^a | A |
| Continuous Drain Current $(T_j = 175 C)$ | T _C = 125 °C | | 47 | |
| Pulsed Drain Current | I _{DM} | 120 | | |
| Avalanche Current | I _{AR} | 40 | | |
| Repetitive Avalanche Energy ^b | L = 0.1 mH | E _{AR} | 80 | mJ |
| | T _C = 25 °C | Р | 100 ^c | 14/ |
| Maximum Power Dissipation ^b | T _A = 25 °C ^d | – P _D – | 3.75 | W |
| Operating Junction and Storage Temperature Ra | T _J , T _{stg} | - 55 to 175 | °C | |

| THERMAL RESISTANCE RATINGS | | | | | | |
|----------------------------|------------------------|-------------------|-------|------|--|--|
| Parameter | | Symbol | Limit | Unit | | |
| Junction-to-Ambient | PCB Mount ^d | R _{thJA} | 40 | °C/W | | |
| Junction-to-Case | | R _{thJC} | 1.4 | C/W | | |

Notes:

a. Package limited.

b. Duty cycle \leq 1 %.

c. See SOA curve for voltage derating.

d. When Mounted on 1" square PCB (FR-4 material).

* Pb containing terminations are not RoHS compliant, exemptions may apply.

SUM70N04-07L

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| Parameter | Symbol | Test Conditions | Min. | Тур. | Max. | Unit | |
|---|----------------------|--|------|--------|----------|------|--|
| Static | | | | | | | |
| Drain-Source Breakdown Voltage | V _{(BR)DSS} | $V_{DS} = 0 V$, $I_{D} = 250 \mu A$ | 40 | | | V | |
| Gate-Threshold Voltage | V _{GS(th)} | $V_{DS} = V_{GS}, I_D = 250 \ \mu A$ | 1 | | 3 | | |
| Gate-Body Leakage | I _{GSS} | $V_{DS} = 0 V, V_{GS} = \pm 20 V$ | | | 100 | nA | |
| | | $V_{DS} = 32 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$ | | | 1 | 0 μΑ | |
| Zero Gate Voltage Drain Current | I _{DSS} | V_{DS} = 32 V, V_{GS} = 0 V, T_{J} = 125 °C | | | 50 | | |
| | | V_{DS} = 32 V, V_{GS} = 0 V, T_{J} = 175 °C | | | 250 | | |
| On-State Drain Current ^a | I _{D(on)} | $V_{DS} \ge 5 \text{ V}, \text{ V}_{GS} = 10 \text{ V}$ | 100 | | | Α | |
| | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$ | | 0.006 | 0.0074 | | |
| | | V _{GS} = 4.5 V, I _D = 10 A | | 0.0085 | 0.011 | | |
| Drain-Source On-State Resistance ^a | r _{DS(on)} | V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 125 °C | | | 0.012 | Ω | |
| | | V_{GS} = 10 V, I_{D} = 30 A, T_{J} = 175 °C | | | 0.015 | | |
| Forward Transconductance ^a | 9 _{fs} | V _{DS} = 15 V, I _D = 30 A | 20 | | | S | |
| Dynamic ^b | 44 | | | 4 | ι ι | | |
| Input Capacitance | C _{iss} | | | 2800 | | pF | |
| Output Capacitance | C _{oss} | $V_{GS} = 0 V$, $V_{DS} = 25 V$, f = 1 MHz | | 320 | | | |
| Reverse Transfer Capacitance | C _{rss} | | | 190 | | | |
| Total Gate Charge ^c | Qg | | | 50 | 75 | nC | |
| Gate-Source Charge ^c | Q _{gs} | $V_{DS} = 20 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 50 \text{ A}$ | | 10 | | | |
| Gate-Drain Charge ^c | Q _{gd} | | | 10 | | | |
| Gate Resistance | R _G | | | 2.0 | | Ω | |
| Turn-On Delay Time ^c | t _{d(on)} | | | 11 | 20 | | |
| Rise Time ^c | t _r | $V_{DD} = 20 \text{ V}, \text{ R}_{\text{I}} = 0.4 \Omega$ | | 20 | 30 | ns | |
| Turn-Off Delay Time ^c | t _{d(off)} | $I_D \cong 50 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{G}} = 2.5 \Omega$ | | 40 | 60 | | |
| Fall Time ^c | t _f | | | 15 | 25 | | |
| Source-Drain Diode Ratings and Cha | aracteristics T | C _C = 25 °C ^b | | | 1 | | |
| Continuous Current | ۱ _S | | | | 66 | | |
| Pulsed Current | I _{SM} | | | | 100 | A | |
| Forward Voltage ^a | V _{SD} | I _F = 50 A, V _{GS} = 0 V | | 1.0 | 1.5 | V | |
| Reverse Recovery Time | t _{rr} | | | 30 | 50 | ns | |
| Peak Reverse Recovery Current | I _{RM(REC)} | I _F = 50 A, di/dt = 100 A/μs | | 1.6 | 2.4 | А | |
| Reverse Recovery Charge | Q _{rr} | | | 0.024 | 0.06 | μC | |

Notes:

a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



SUM70N04-07L

T_C = 125 °C

2.5

 $V_{GS} = 10 V$

60

I_D - Drain Current (A)

80

100

40

20

Gate Charge

30

3.0 3.5 4.0

25 °

2.0

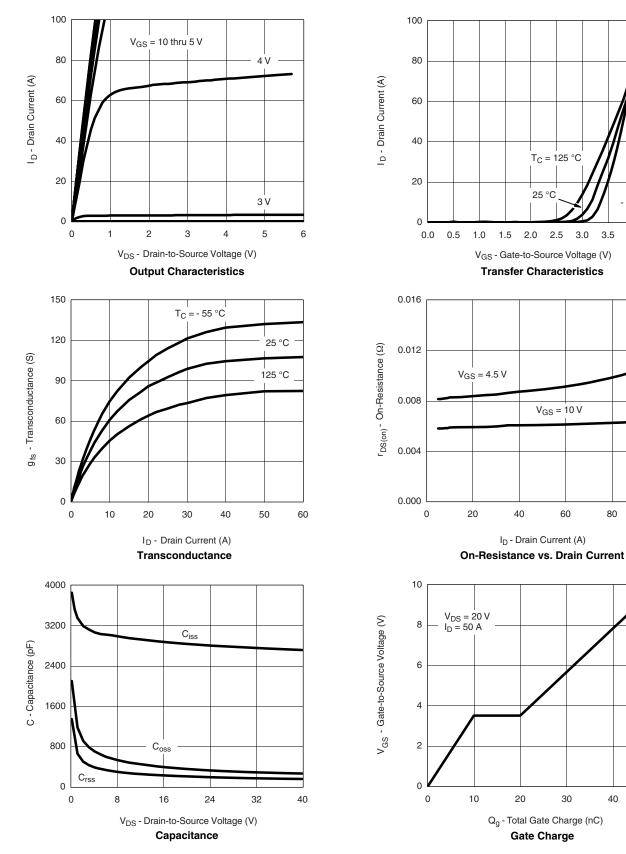
1.5

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- 55 °C

4.5

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

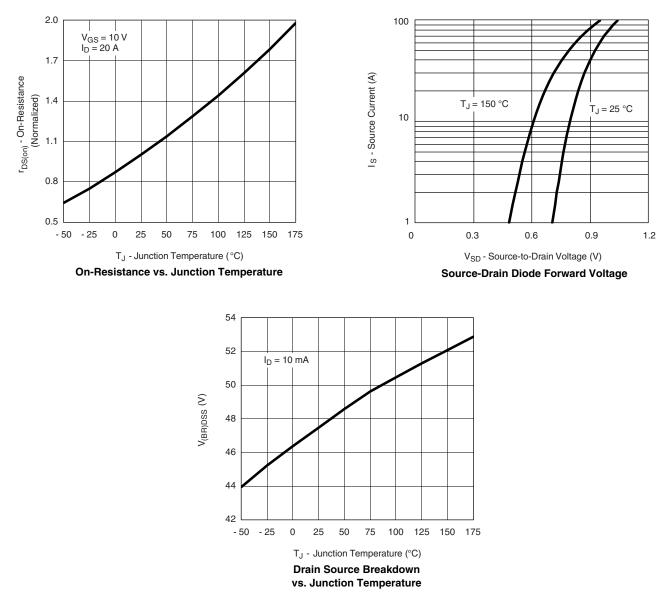


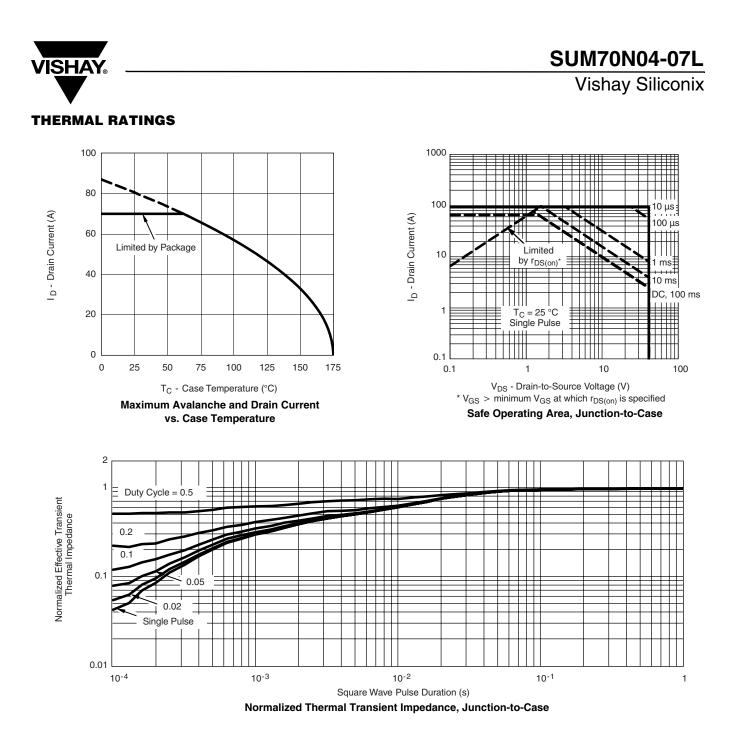
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





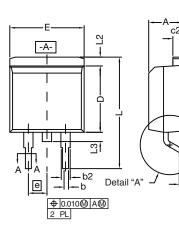
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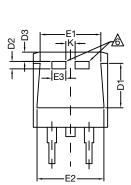


Package Information

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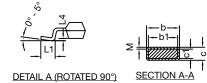
TO-263 (D²PAK): 3-LEAD





-B-

С



| | | INCHES | | MILLIMETERS | | |
|--|------------|-----------|-----------|-------------|--------|--|
| DIM. | | MIN. | MAX. | MIN. | MAX. | |
| А | | 0.160 | 0.190 | 4.064 | 4.826 | |
| | b | 0.020 | 0.039 | 0.508 | 0.990 | |
| | b1 | 0.020 | 0.035 | 0.508 | 0.889 | |
| | b2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| с* | Thin lead | 0.013 | 0.018 | 0.330 | 0.457 | |
| C | Thick lead | 0.023 | 0.028 | 0.584 | 0.711 | |
| c1 | Thin lead | 0.013 | 0.017 | 0.330 | 0.431 | |
| CI | Thick lead | 0.023 | 0.027 | 0.584 | 0.685 | |
| | c2 | 0.045 | 0.055 | 1.143 | 1.397 | |
| | D | 0.340 | 0.380 | 8.636 | 9.652 | |
| | D1 | 0.220 | 0.240 | 5.588 | 6.096 | |
| D2 | | 0.038 | 0.042 | 0.965 | 1.067 | |
| D3 | | 0.045 | 0.055 | 1.143 | 1.397 | |
| E | | 0.380 | 0.410 | 9.652 | 10.414 | |
| | E1 | 0.245 | - | 6.223 | - | |
| | E2 | 0.355 | 0.375 | 9.017 | 9.525 | |
| | E3 | 0.072 | 0.078 | 1.829 | 1.981 | |
| | е | 0.100 | 0.100 BSC | | BSC | |
| | К | 0.045 | 0.055 | 1.143 | 1.397 | |
| | L | 0.575 | 0.625 | 14.605 | 15.875 | |
| L1 | | 0.090 | 0.110 | 2.286 | 2.794 | |
| L2 | | 0.040 | 0.055 | 1.016 | 1.397 | |
| L3 | | 0.050 | 0.070 | 1.270 | 1.778 | |
| | L4 | 0.010 BSC | | 0.254 BSC | | |
| М | | - | 0.002 | - | 0.050 | |
| ECN: T10-0738-Rev. J, 03-Jan-11 DWG: 5843 | | | | | | |

Notes

- 1. Plane B includes maximum features of heat sink tab and plastic.
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils.
- 3. Pin-to-pin coplanarity max. 4 mils.
- 4. *: Thin lead is for SUB, SYB.
- Thick lead is for SUM, SYM, SQM.
- 5. Use inches as the primary measurement.



RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead



Recommended Minimum Pads Dimensions in Inches/(mm)

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